MT THERM™ BORON NITRIDE FILLERS

THERMAL MANAGEMENT FOR ELECTRIC VEHICLE APPLICATIONS





MT THERM™ BORON NITRIDE FILLERS

ELECTRIC VEHICLE APPLICATIONS

THERMAL MANAGEMENT FOR ELECTRIC VEHICLES

Thermal management plays a vital role in maximizing the safety, performance, efficiency and overall longevity of electric vehicles (EV). Multiple components in EVs, such as power electronics, e-motors, and batteries require adequate thermal management as the industry is pushing for higher power, higher voltage, faster data transmission, lighter weight, and smaller size. Thermally conductive, but electrically insulating thermal interface materials (TIMs) with high dielectric strength and low dielectric constant are needed to meet these thermal management challenges. Since TIMs made of dielectric polymers are naturally thermally insulative, ceramic fillers need to be added to improve thermal conductivity while maintaining electrical resistance. Superior thermal and dielectric properties of the ceramic thermal fillers are key to the success of thermal management materials.

CERAMIC THERMAL FILLER PROPERTIES

BORON NITRIDE MEETS THE CHALLENGE

Thermal interface materials loaded with hexagonal **Boron Nitride** (BN) meet the challenges of offering high thermal conductivity (TC), high dielectric breakdown strength (DBS), low dielectric constant (Dk), low coefficient of thermal expansion (CTE), and low density to EV systems.

APPLICATIONS IN ELECTRIC VEHICLES

- TIMS FOR POWER ELECTRONIC COMPONENTS SUCH AS INVERTERS/CONVERTERS
- PCB LAMINATES FOR EV ELECTRONICS
- THERMAL MANAGEMENT MATERIALS FOR E-MOTORS
- TIMs FOR BATTERY ASSEMBLIES

TYPICAL PROPERTIES	BN	AIN	Al ₂ O ₃	SiO₂	ZnO
Thermal Conductivty (W/m-K)	300*	260	30	1.4	54
Specific Heat (J/kg-K @ 25°C)	800	730	800	690	520
Theoretical Density (g/cc)	2.2	3.2	4.0	2.2	5.6
Dielectric Constant	3.9	8.8	9.7	3.8	9.9
Volume Resistivity (ohm-cm)	10 ¹⁵	1014	1014	10 ¹⁴	10 ⁷
Coefficient of Thermal Expansion (ppm/K)	<1	4.4	6.7	<1	<1
Mohs Hardness	2	7	9	6	5

* Thermal conductivity in crystal plane

ADVANTAGES OF BN FILLERS

- HIGH THERMAL CONDUCTIVITY
- HIGH BREAKDOWN VOLTAGE
- LOW DIELECTRIC CONSTANT
- LIGHT WEIGHT
- MECHANICAL COMPLIANCE
- THERMALLY STABLE
- CHEMICALLY INERT
- WHITE COLOR

HIGH THERMAL CONDUCTIVITY

Boron Nitride has one of the highest thermal conductivities and electrical insulative properties of ceramic fillers. This, along with low dielectric loss characteristics, makes BN a highly desired filler in epoxies, silicones, and PU systems. Compared to other ceramic fillers such as spherical alumina, BN enables superior thermal and electrical performance, capable of providing more than 2x thermal conductivity and improved electrical breakdown properties. This is achieved with less volume loading compared to other fillers, and less impact to mechanical properties such as hardness. Higher thermal conductivities enable higher power through the circuits.

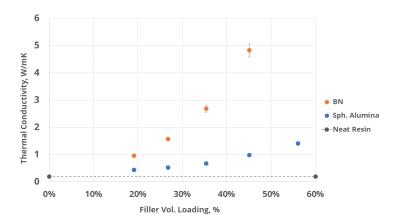


CHART 1: Thermal conductivity measured in silicone resin system, via HotDisk* method. Performances in other resin systems would be similar.

HIGH DIELECTRIC BREAKDOWN STRENGTH

For package and board level thermal management, higher thermal conductivities coupled with thinner bond lines of the dielectric layers enables lower thermal resistance. With increasing voltages in power electronics such as in EVs, maximizing electrical isolation in these thin dielectric layers becomes crucial. BN has one of the highest breakdown strengths (Eb) among fillers, enabling lower bond line thicknesses compared to others. The breakdown strength of BN filled system compares favorably with spherical alumina filled system at equivalent volume loadings.

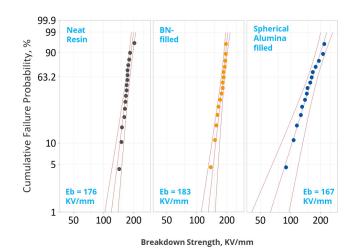
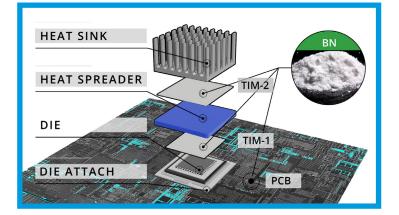


CHART 2: Breakdown strength measured in an epoxy resin system. Relative performances in other resin systems would be similar.

The inherent softness of BN as a filler ensures good contact between the component, heat sink and the TIM thereby minimizing contact resistances.





HIGH-QUALITY SIGNAL TRANSMISSION

For high-speed data transmission and high-voltage, high frequency applications related to EVs, dielectric constant impacts the signal integrity and impedance. Lower Dk materials are preferred for high-speed signals to reduce losses, signal distortion, and minimize cross talk between closely spaced traces and vias.

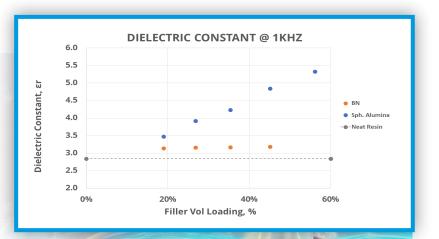
Boron Nitride has one of the lowest Dk of thermal fillers. Coupled with its very low dielectric loss properties, Df, Boron Nitride fillers enable low loss and excellent signal transmission/ low attenuation at high frequencies and for high voltage applications.

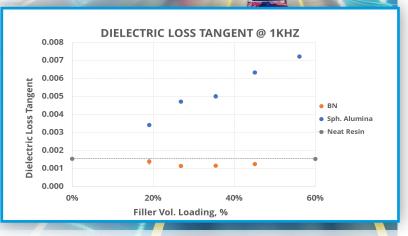
These combined properties of Boron Nitride make it a very attractive material for use in thermal management materials in power electronics, electric motors, battery assemblies, and high frequency signal processing components in EV applications.



OUR EXPERTS ARE READY

Momentive Technologies is a leading supplier globally for high quality Boron Nitride products with a broad portfolio of more than 50 grades. Our MT Therm series of Boron Nitride powders are tailored to thermal management needs of EV applications. Our application development engineering team can provide detailed technical support to help customers select the best BN products for their specific requirements.





Dielectric properties measured in a silicone resin system. Relative performances in other resin systems would be similar.





Patent Status

Nothing contained herein shall be construed to imply the nonexistence of any relevant patents or to constitute the permission, inducement or recommendation to practice any invention covered by any patent, without authority from the owner of the patent.

Product Safety, Handling and Storage

Customers should review the latest Material Safety Data Sheet (MSDS) and label for product safety information, safe handling instructions, personal protective equipment if necessary, emergency service contact information, and any special storage conditions required for safety. For product storage and handling procedures to maintain the product quality within our stated specifications, please review Certificates of Analysis, which are available in the Order Center.

Limitations

Customers must evaluate Momentive Performance Materials Quartz, Inc. ("Momentive Technologies") products and make their own determination as to fitness of use in their particular applications.

DISCLAIMER

THE MATERIALS, PRODUCTS AND SERVICES OF MOMENTIVE TECHNOLOGIES, ITS SUBSIDIARIES AND AFFILIATES, ARE SOLD SUBJECT TO MOMENTIVE TECHNOLOGIES' STANDARD TERMS AND CONDITIONS OF SALE. MOMENTIVE TECHNOLOGIES MAKES NO WARRANTY OR GUARANTEE, EXPRESS OR IMPLIED, (i) THAT THE RESULTS DESCRIBED HEREIN WILL BE OBTAINED UNDER END-USE CONDITIONS, OR (ii) AS TO THE EFFECTIVENESS OR SAFETY OF ANY DESIGN INCORPORATING ITS PRODUCTS, MATERIALS, SERVICES, RECOMMENDATIONS OR ADVICE. IN NO EVENT SHALL MOMENTIVE TECHNOLOGIES OR ITS REPRESENTATIVES BE RESPONSIBLE FOR ANY LOSS RESULTING FROM ANY USE OF ITS MATERIALS, PRODUCTS OR SERVICES DESCRIBED HEREIN.

Each user bears full responsibility for making its own determination as to the suitability of Momentive Technologies' materials, services, recommendations, or advice for its own particular use. Each user must identify and perform all tests and analyses necessary to assure that its finished parts incorporating Momentive Technologies' products, materials, or services will be safe and suitable for use under end-use conditions. No statement contained herein concerning a possible or suggested use of any material, product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right of Momentive Technologies or any of its subsidiaries or affiliates covering such use or design, or as a recommendation for the use of such material, product, service or design in the infringement of any patent or other intellectual property right.

CUSTOMER SERVICE CENTERS

North America

SalesCeramics@momentivetech.com +1 440 878 5700

Europe

cs-eur.ceramics@momentivetech.com +49 4152 9380

Asia

info@momentivetech.com



